

# PS2733-1

HIGH COLLECTOR TO EMITTER VOLTAGE SOP MULTI PHOTOCOUPLER

# DESCRIPTION

The PS2733-1 are optically coupled isolators containing a GaAs light emitting diode and an NPN silicon darlington-connected phototransistor.

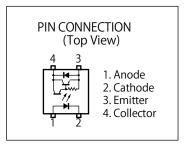
This package is SOP (Small Outline Package) type and has shield effect to cut off ambient light. It is designed for high density mounting applications.

### **FEATURES**

- High isolation voltage (BV = 2 500 Vr.m.s.)
- High collector to emitter voltage (V<sub>CEO</sub> = 350 V)
- Small and thin package (4-pin SOP)
- High current transfer ratio (CTR = 4 000% TYP.)
- Ordering number of taping product: PS2733-1-F3: 3 500 pcs/reel
- Pb-Free product
- Safety standards
  - UL approved: UL1577, Single protection
  - CSA approved: CAN/CSA-C22.2 No. 62368-1, Basic/Supplementary insulation
  - BSI approved: BS EN 62368-1, Basic/Supplementary insulation
  - VDE approved: DIN EN 60747-5-5 (Option)

### APPLICATIONS

- Hybrid IC
- Telephone/Telegraph Receiver
- FAX

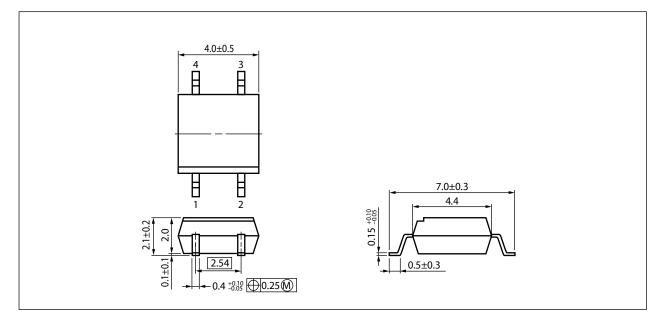


R08DS0162EJ0100

Rev.1.00 Jun 19, 2019



# PACKAGE DIMENSIONS (UNIT: mm)

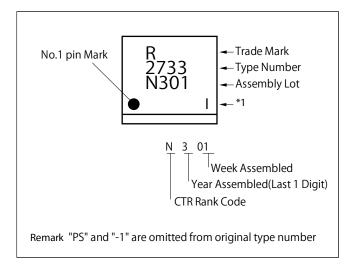


# PHOTOCOUPLER CONSTRUCTION

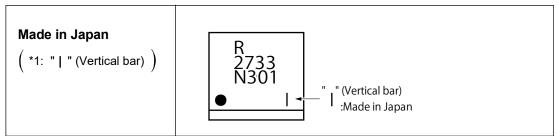
Parameter	Unit (MIN.)
Air Distance	5 mm
Creepage Distance	5 mm
Isolation Distance	0.3 mm



# MARKING EXAMPLE



Note: Bar indication contents of \*1.





Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number <sup>*1</sup>
PS2733-1-F3	PS2733-1-F3-A	Pb-Free	Embossed Tape 3 500 pcs/reel	Standard products (UL, CSA, BSI approved)	PS2733-1
PS2733-1-V-F3	PS2733-1-V-F3-A		Embossed Tape 3 500 pcs/reel	UL, CSA, BSI, DIN EN 60747-5-5 approved	

ORDERING INFORMATION

Note: \*1. For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current (DC)	lF	50	mA
	Reverse Voltage	VR	6	V
	Power Dissipation Derating	⊿P <sub>D</sub> /°C	0.8	mW/°C
	Power Dissipation	PD	80	mW
	Peak Forward Current*1	IFP	1	A
Transistor	Collector to Emitter Voltage	Vceo	350	V
	Emitter to Collector Voltage	V <sub>ECO</sub>	0.3	V
	Collector Current	lc	150	mA
	Power Dissipation Derating	⊿Pc/°C	1.5	mW/°C
Power Dissipation		Pc	150	mW
Isolation Voltage*2		BV	2 500	Vr.m.s.
Operating A	Operating Ambient Temperature		–55 to +100	°C
Storage Temperature		T <sub>stg</sub>	–55 to +150	°C

Note: \*1. PW = 100  $\mu$ s, Duty Cycle = 1%

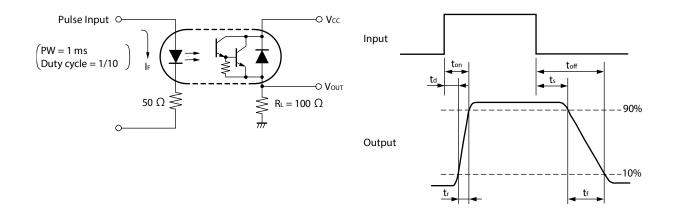
\*2. AC voltage for 1 minute at  $T_A = 25^{\circ}$ C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.



	Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	VF	I <sub>F</sub> = 10 mA		1.15	1.4	V
	Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V			5	μs
	Terminal Capacitance	Ct	V = 0 V, f = 1.0 MHz		30		pF
Transistor	Collector to Emitter Dark Current	I <sub>CEO</sub>	I <sub>F</sub> = 0 mA, V <sub>CE</sub> = 300 V			400	nA
Coupled	Current Transfer Ratio (I <sub>C</sub> /I <sub>F</sub> )	CTR	I <sub>F</sub> = 1 mA, V <sub>CE</sub> = 2 V	1 500	4 000		%
	Collector Saturation Voltage	V <sub>CE (sat)</sub>	I <sub>F</sub> = 1 mA, I <sub>C</sub> = 2 mA			1.0	V
	Isolation Resistance	R <sub>I-O</sub>	V <sub>I-O</sub> = 1.0 kV <sub>DC</sub>	10 <sup>11</sup>			Ω
	Isolation Capacitance	CI-O	V = 0 V, f = 1.0 MHz		0.4		pF
	Rise Time <sup>*1</sup>	tr	$V_{CC}$ = 5 V, $I_C$ = 10 mA, $R_L$ = 100 $\Omega$		100		μs
	Fall Time <sup>*1</sup>	t <sub>f</sub>	1		100		

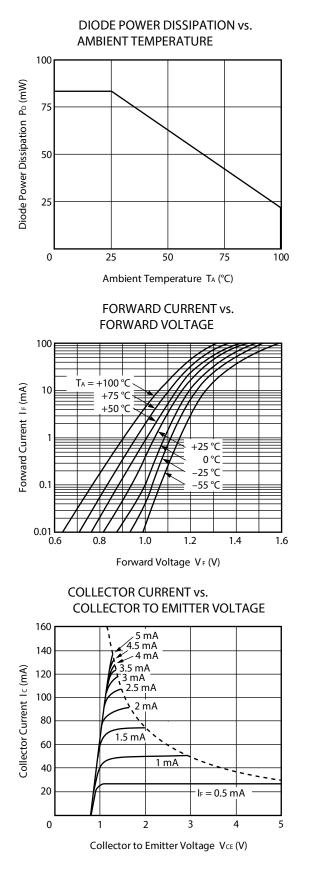
# ELECTRICAL CHARACTERISTICS ( $T_A = 25^{\circ}C$ )

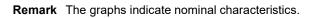
Note: \*1. Test Circuit for Switching Time

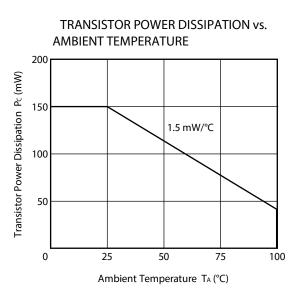




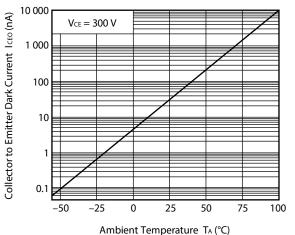
# **TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C, unless otherwise specified)**



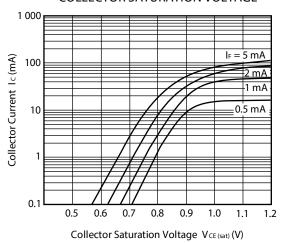


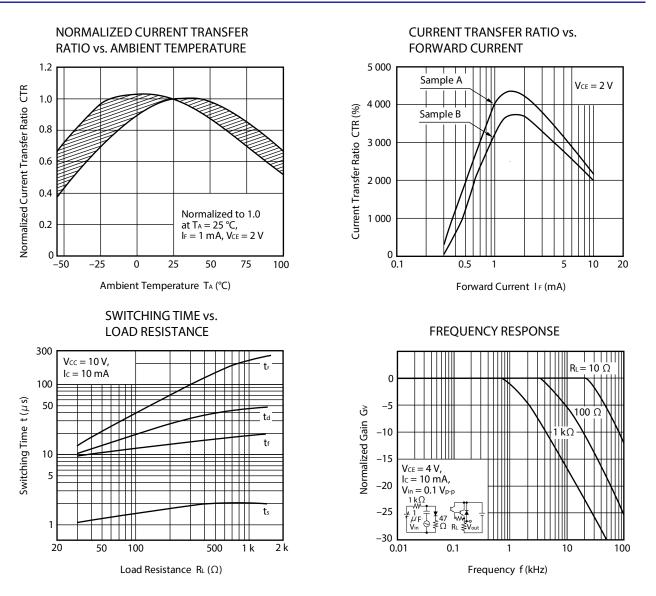


COLLECTOR TO EMITTER DARK CURRENT vs. AMBIENT TEMPERATURE



COLLECTOR CURRENT vs. COLLECTOR SATURATION VOLTAGE

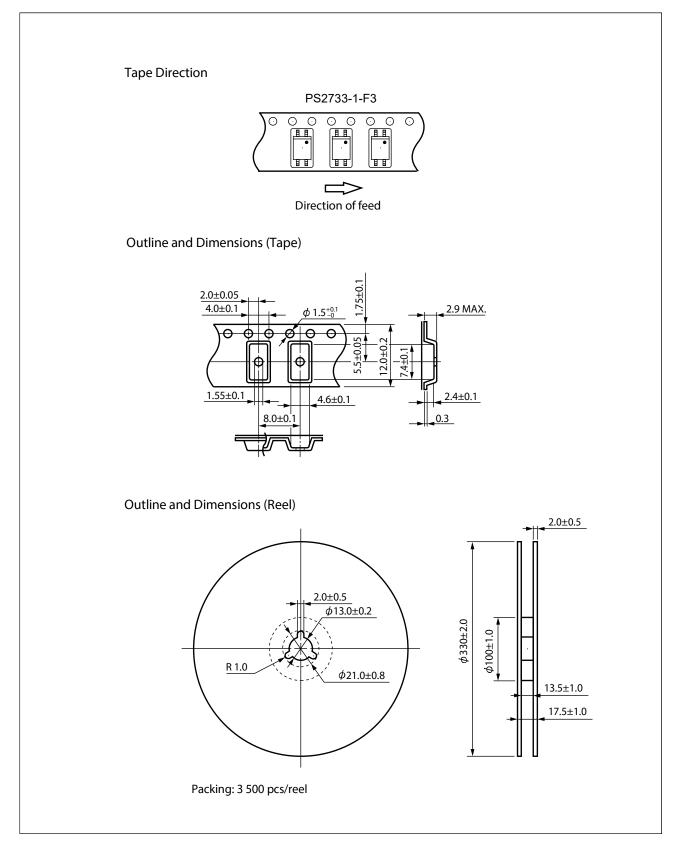




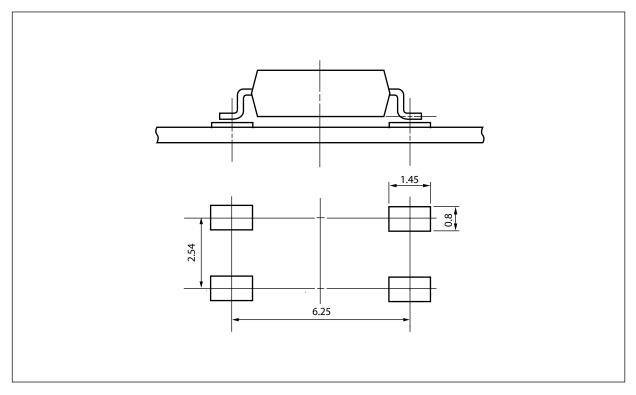
Remark The graphs indicate nominal characteristics.



# TAPING SPECIFICATIONS (UNIT: mm)



# RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



**Remark** All dimensions in this figure must be evaluated before use.



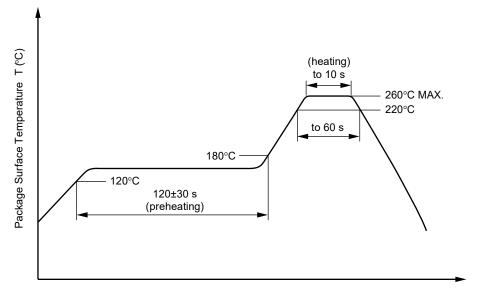
# NOTES ON HANDLING

- 1. Recommended soldering conditions
  - (1) Infrared reflow soldering
    - Peak reflow temperature
    - Time of peak reflow temperature
    - Time of temperature higher than 220°C
    - Time to preheat temperature from 120 to 180°C
    - Number of reflows
    - Flux

#### 260°C or below (package surface temperature) 10 seconds or less 60 seconds or less 120±30 s Three Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of

0.2 Wt% is recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

- (2) Wave soldering
  - Temperature 260°C or below (molten solder temperature)
  - Time 10 seconds or less
  - Preheating conditions 120°C or below (package surface temperature)
  - Number of times One (Allowed to be dipped in solder including plastic mold portion.)
    - Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

#### (3) Soldering by Soldering Iron

Time (each pins)

• Peak Temperature (lead part temperature) 350°C or below

3 seconds or less

• Flux

• Flux

Rosin flux containing small amount of chlorine

(The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

- (a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead
- (b) Please be sure that the temperature of the package would not be heated over 100°C
- (4) Cautions
  - Flux Cleaning

Avoid cleaning with Freon based or halogen-based (chlorinated etc.) solvents.

• Do not use fixing agents or coatings containing halogen-based substances.

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2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

### **USAGE CAUTIONS**

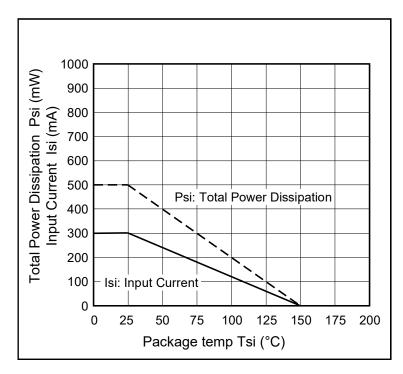
- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.



SPECIFICATION	OF VI	DE MARKS	LICENSE	DOCUMENT
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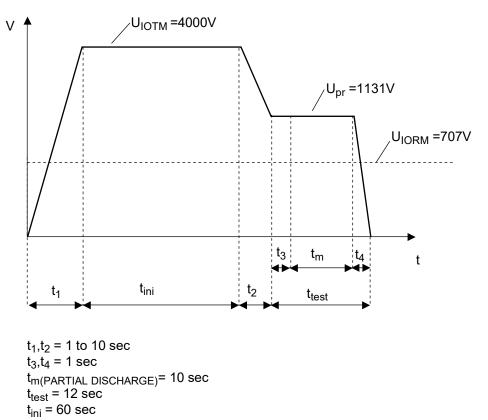
Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		55/100/21	
Dielectric strength			
maximum operating isolation voltage	UIORM	707	V <sub>peak</sub>
Test voltage (partial discharge test, procedure a for type test and	U <sub>pr</sub>	1 131	V <sub>peak</sub>
random test)			
Upr = $1.6 \times U_{IORM}$ , $P_d < 5 \text{ pC}$			
Test voltage (partial discharge test, procedure b for all devices)	Upr	1 325	V <sub>peak</sub>
$U_{pr}$ = 1.875 × $U_{IORM}$ , $P_d$ < 5 pC			
Highest permissible overvoltage	UIOTM	4 000	V <sub>peak</sub>
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	CTI	175	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		lll a	
Storage temperature range	T <sub>stg</sub>	–55 to +150	°C
Operating temperature range	TA	–55 to +100	°C
Isolation resistance, minimum value			
$V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$	Ris MIN.	10 <sup>12</sup>	Ω
V <sub>IO</sub> = 500 V dc at T <sub>A</sub> MAX. at least 100°C	Ris MIN.	10 <sup>11</sup>	Ω
Safety maximum ratings (maximum permissible in case of fault, see			
thermal derating curve)			
Package temperature	Tsi	150	°C
Current (input current I <sub>F</sub> , Psi = 0)	lsi	300	mA
Power (output or total power dissipation)	Psi	500	mW
Isolation resistance			
V <sub>IO</sub> = 500 V dc at T <sub>A</sub> = Tsi	Ris MIN.	10 <sup>9</sup>	Ω

# Dependence of maximum safety ratings with package temperature

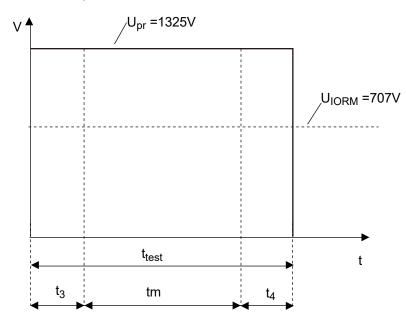








Method b) Non-destructive Test, 100% Production Test



 $t_3, t_4 = 0.1 \text{ sec}$  $t_m(\text{PARTIAL DISCHARGE})= 1.0 \text{ sec}$  $t_{test} = 1.2 \text{ sec}$ 



Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.
	• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
	<ol> <li>Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.</li> </ol>
	<ol><li>Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.</li></ol>
	Do not burn, destroy, cut, crush, or chemically dissolve the product.
	• Do not lick the product or i any way allow it to enter the mouth.

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